

41. The method of claim **31**, further comprising coupling a polyethylene terephthalate (PET) subassembly to the glass subassembly, the PET subassembly representing the dielectric material, and forming the second traces on a top side of the PET subassembly.

42. The method of claim **41**, further comprising forming a continuous sheet of conductive material on a bottom side of the PET subassembly for shielding the first traces.

43. A method for forming a multi-touch sensor panel, comprising:

forming a plurality of mutual capacitance sensors by layering a plurality of first traces of a first substantially transparent conductive material and a plurality of second traces of a second substantially transparent conductive material separated by a dielectric material, and orienting the plurality of first and second traces to cross over each other at crossover locations separated by the dielectric material, the crossover locations forming the mutual capacitance sensors;

wherein one or both of the plurality of first traces and the plurality of second traces are formed on a back side of a glass subassembly, the glass subassembly having a front side opposite the back side and capable of being touched.

44. The method of claim **43**, wherein the first and second substantially transparent conductive materials are the same.

45. The method of claim **43**, further comprising forming a mask layer on the back side of the glass subassembly for hiding electrical interconnect.

46. The method of claim **43**, further comprising forming the dielectric material over the first traces on the back side of

the glass subassembly to create a planarization layer for use in forming subsequent conductive layers.

47. The method of claim **46**, further comprising forming the second traces over the dielectric material on the back side of the glass subassembly.

48. The method of claim **47**, further comprising coupling a polyethylene terephthalate (PET) subassembly to the glass subassembly, and forming a continuous sheet of conductive material on the PET subassembly for shielding the first traces.

49. The method of claim **48**, further comprising coupling a liquid crystal display (LCD) module to the PET subassembly.

50. The method of claim **43**, further comprising coupling a polyethylene terephthalate (PET) subassembly to the glass subassembly, the PET subassembly representing the dielectric material and the second traces formed on a bottom side of the PET subassembly.

51. The method of claim **50**, further comprising coupling a chip on glass to the glass subassembly, the chip on glass including sensor panel circuitry.

52. The method of claim **51**, further comprising coupling a liquid crystal display (LCD) module to the PET subassembly.

53. The method of claim **43**, further comprising coupling a polyethylene terephthalate (PET) subassembly to the glass subassembly, the PET subassembly representing the dielectric material, and forming the second traces on a top side of the PET subassembly.

54. The method of claim **53**, further comprising forming a continuous sheet of conductive material on a bottom side of the PET subassembly for shielding the first traces.

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